10ZC+10ZCWY

Round cap • low total height • panel sealed



MEC. Palc. Palchy 1221

DISTINCTIVE FEATURES

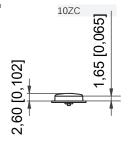
Round cap Ø9.58 mm, h=7.6 mm Slightly convex cap for good haptic feel Panel sealed to IP67 Anti-rotation for printed caps Can be designed-in together with Ultranavimec™

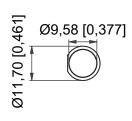


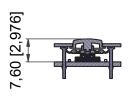
SWITCH SPECIFICATIONS: see Ultramec™ series

6C+10ZC+10ZCWY-J-BEND

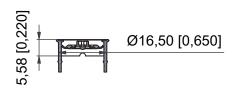


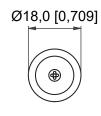


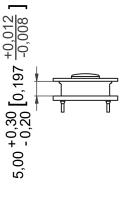












10ZC+10ZCWY

Round cap • low total height

panel sealed



GENERAL SPECIFICATIONS

- Front panel sealing: IP67 to IEC 60529
- Mechanical lifecycle (sealing): 500,000 activations
- Recommended panel thickness: 1.0 mm

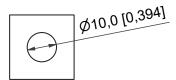


MATERIALS

- · Sealing: silicone
- Non-illuminated cap: ABS
- Illuminated cap: polycarbonate (PC)



PANEL CUT-OUT





ASSEMBLY

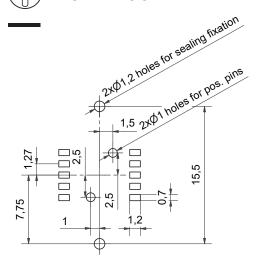


The positioning pins on the sealing are used to fix the sealing to the PCB during the assembly.

The sealing is mounted by inserting the pins into the PCB, then pulling the pins from the back side until the locking mechanisms have come through the mounting holes, and then releasing the pins.



PCB LAYOUT





LEGENDS

Please note that anti-rotation is established with the cross in the bottom of the cap that insert into the sealing.

The cut-out is for production purpose and it will be used to indicate the direction of the legend. In case of the standard printed legends the cut-out is placed left from the legend.

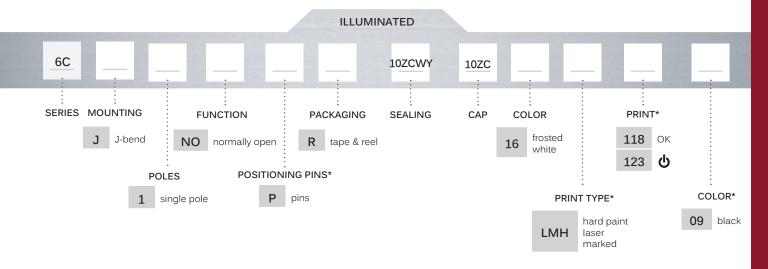
APEN

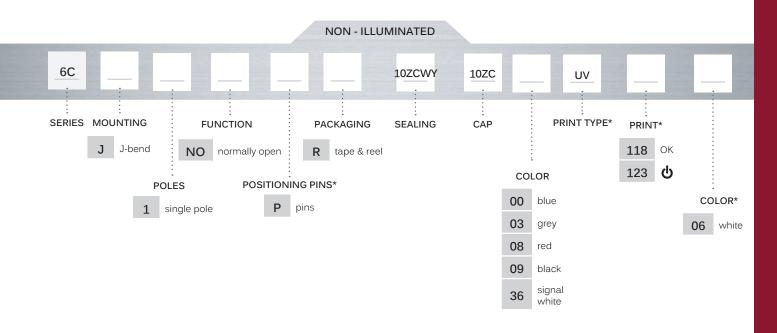
10ZC+10ZCWY

Round cap • low total height • panel sealed



BUILD YOUR PART NUMBER





*optional

NOTICE: Please note that not all combinations are standard. Contact APEM for further info. Please note that the switches, caps and sealing are ordered separately.

MECULT RAMEGE 2008

Ultramec[™] 6C

High performance tactile switches • low profile • IP67





DISTINCTIVE FEATURES

Low profile h=2.5 mm 8 x 8 mm Normally open momentary switch Sealed to IP67 3,000,000 cycles lifetime





ENVIRONMENTAL SPECIFICATIONS

- Sealing: IP67 according to IEC 60529
- \bullet Working and storage temperature :-40 °C/+85 °C (-40 °F to 185°F)
- Soldering : JEDEC J-STD-020E



ELECTRICAL SPECIFICATIONS

- Recommended load: 0.5-50 mA 24 VDC
- Contact resistance : <50 mΩ
- Insulation resistance : >10 $M\Omega$
- Contact bounce : <2 mS
- Dielectric strength: 250 V



MECHANICAL SPECIFICATIONS

- Standard actuation force: before soldering 4.2 N ±1.0 N after soldering: 3.7 N ±0.7 N
- Max. actuation force: 100 N for 10 sec
- Travel: 0.3 mm ±0.15 mm
 Lifetime: 3,000,000 cycles
- The company reserves the right to change specifications without notice.



MATERIALS

- Housing: PPS UL94V0
- Actuator : silicone
- Contact dome : stainless steel
- Fixed contacts:
- Silver : CuZn + 1 μNi + 4 μAg
- Terminals : CuZn + 1 μNi

All tolerance if not otherwise specified ±0.2mm.

Ultramec[™] 6C

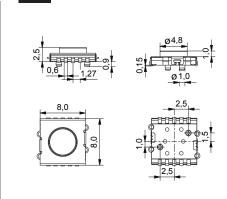
High performance tactile switches • low profile • IP67

6C



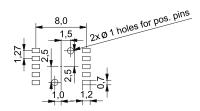
- J-bend
- NO

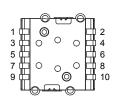
All tolerances unless otherwise noted: ±0.2 mm

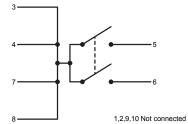




PCB LAYOUT & CIRCUIT DIAGRAM



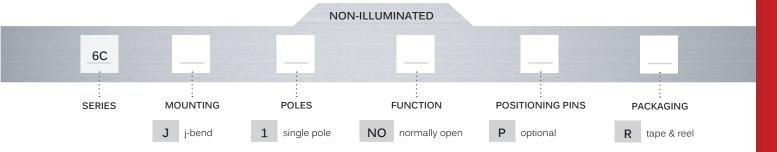




Ultramec[™] 6C

High performance tactile switches • low profile • IP67







(1) Accessories: See APEM website for cap options

Ultramec[™] 6C

High performance tactile switches • low profile • IP67



TAPE & REEL

Tape and reel is available for the parts listed and has the following specifications

• Reel diameter: Ø330 mm

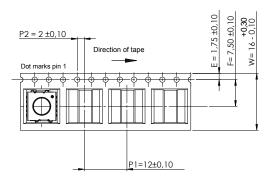
• Tape width: 16 mm

• Pitch: see list

• Tape and reel material : antistatic or better

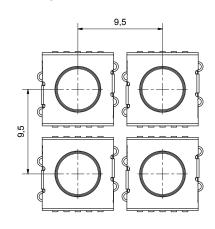
• Quantity per reel : see list

PART NO.	ORDERING CODE	PITCH	QUANTITY PER REEL
6CJ1NOP	6CJ1NOPR	12	1000
6CJ1NO	6CJ1NOR	12	1000





SPACE REQUIREMENT - MATRIX MOUNTING



surface mount (J-bend)

VPEM

Ultramec[™] 6C

High performance tactile switches • low profile • IP67



USAGE GUIDELINES

HOW TO GET THE BEST RESULTS WITH MEC SWITCHES?

These guidelines are offered to users of MEC Switches as an aid to ensure successful and reliable switch operation. Please see the technical specifications for details on operating and storage temperatures and soldering guidelines to make sure you select the best switch for your application.

When reflow soldering is taking place, MEC strongly recommend that the temperature profile is analyzed and compared with the temperature rating of the switch. It is also important to monitor the accumulated heat buildup from both the pre-heat zones and the solder zone.

Standard accessories for Ultramec[™] 6 series switches are made from ABS plastic with a maximum operating temperature of 65 °C.

MOUNTING AND DISMOUNTING

If switches are to be mounted in rows, it is essential that the recommendations regarding spacing are followed. PC board thickness should be 1.4 ± 0.2 mm.

SOLDERING AND CLEANING ULTRAMEC™ SERIES

Ultramec[™] series switches are fully sealed to IP67 specifications to minimize solder flux and aqueous based cleaning solutions from entering the switch and contaminating the contacts. The switches can be placed on the PC board with other components and reflow soldered. Ultramec[™] series offers a high level of sealing, however, with aqueous solvent solutions care must be taken to avoid the worst case situation with water jets, complete immersion into a liquid with a temperature below the board or surface tension reducing additives.

Recommended cleaning methods are demineralized water. Any surface tension reducing agents, such as soap, must not be used as they risk causing a potential leakage of the switch.

SOLDERING - SURFACE MOUNT VERSIONS

For all methods - infrared, convection and vapor phase. The upper limit 240 °C/40 sec must be observed. The soldering temperature profile must have moderate temperature gradients. (JEDEC J-STD-020E)

ROHS COMPLIANCE

As of 1 July 2006 MEC has completed the conversion to RoHS compliance. For more info please see our homepage www.apem.com

TEMPERATURE LIMITS:

Switch 160 °C Accessories 65 °C

PACKAGING

Ultramec[™] series switches are delivered on tape/reel. Each reel contains 1000 pcs. It is also possible to purchase half full reels.